

UNITED STATES PATENT APPLICATION

for

**NON-VOLATILE ALTERABLE DEFAULT FLASH MEMORY
CONFIGURATION REGISTERS**

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NON-VOLATILE ALTERABLE DEFAULT FLASH MEMORY CONFIGURATION REGISTERS

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BACKGROUND OF THE INVENTION

1. Field of the Invention

[0001] The invention pertains generally to computers. In particular, it pertains
10 to computer memory.

2. Description of the Related Art

[0002] Flash memory is commonly used for applications that require a non-
volatile memory to store code and data that must be retained when power to the
15 memory is removed, but which can be re-written when necessary during operation.
Flash memory is favored because it can be written and erased while in-circuit, and
because it has read access times comparable to static random access memory (SRAM).
Its primary disadvantage is that it can only be erased in blocks, with a block typically
being several thousand bytes, and the erase function can take a relatively long time to
20 accomplish. This makes minor changes to the memory contents somewhat
cumbersome to perform.

[0003] Generic flash memory can be manufactured and then provided to
multiple equipment makers who place the flash memory into various products that have
differing memory configuration requirements. Some of these configuration
25 requirements deal with the way memory is partitioned, such as by providing predefined
protected blocks that cannot be rewritten without having special access privileges.

Other requirements may deal with the polarity of certain memory interface signals, such as whether address lines are to be sampled on a rising or falling edge of a clock. Certain memory addresses may be reserved for specific functions external to memory. These and/or other configuration data are typically placed into non-volatile locations during the manufacturing or assembly stages, where they effectively become permanent. When the product is placed into operation, this configuration information is retrieved and loaded each time the system is rebooted or otherwise reset. However, if the configuration data is programmed during memory manufacture, a different configuration must be manufactured for each customer and each product. If it is programmed during assembly of that product by the customer, the customer must acquire, operate, and maintain the equipment for this one-time programming operation. Further, changes in the product that require changes in the configuration may require the customer to physically replace and discard the existing memories in existing products, a field upgrade procedure that can be extremely expensive.

15 [0004] Some product makers may wish to design their product so that the configuration can be temporarily changed for some specific function, thus requiring the configuration to be reprogrammable while in-circuit, a feat that is not feasible in a conventional system with the configuration in permanent memory.

[0005] A conventional alternative to this permanently-programmed configuration is to place the configuration data in a volatile register, which requires the register to be reloaded every time the power turned on. This adds to the system start-up overhead, which should be minimized in many products. This approach also requires the configuration data to be placed into some other non-volatile but programmable location when the power is off so that it will be available to be reloaded when power is turned on.

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[0006] The inherent limitations in these two configuration methods can force the manufacturers to choose between two imperfect approaches, and accept the disadvantages of the choice they make.

BRIEF DESCRIPTION OF THE DRAWINGS

- [0007] Fig. 1 shows a system embodiment.
- [0008] Fig. 2 shows a configuration circuit.
- 5 [0009] Fig. 3 shows a method of loading active configuration data.
- [0010] Fig. 4 shows a method of resetting configuration data.

DETAILED DESCRIPTION OF THE INVENTION

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[0011] Various embodiments of the invention permit a memory, such as a flash memory, to have capabilities for active configuration data that is selectable between default configuration data and programmable configuration data. Various embodiments of the invention can have reset capability that can reset the memory with either the

15 default configuration data or the active configuration data that was being used immediately before the reset condition occurred.

[0012] Default configuration data can be defined as predetermined intended operational configuration data, i.e., the configuration data that is intended to be used unless it is overridden by different configuration data.

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[0013] Programmable configuration data can be defined as configuration data that can be programmed into the memory device during operation, and which can override the default configuration data. Programmable configuration data can be used to accommodate a special or temporary configuration requirement during operation of the system. Programmable configuration data can also be used by a manufacturer who

buys a memory device that has a particular default configuration data, and inserts that memory device into a product that requires a different memory configuration.

[0014] Active configuration data can be the configuration data that is to actually be used, whether or not it is the same as the default configuration data. Active configuration data can be made available to configuration logic that defines how the memory is actually configured. However, in some embodiments, this active configuration data may not be actually implemented to configure the memory until the occurrence of an event, such as the initiation of a reconfiguration sequence in the software.

[0015] Fig. 1 shows a system 1 with a memory 10 coupled to a processor (CPU) 19 by a bus 18. In one embodiment, memory 10 can comprise an integrated circuit, but in alternate embodiments memory 10 can be made up of multiple integrated circuits or a portion of a single integrated circuit, depending on the specific physical construction of memory 10. Memory 10 can include memory array 11 to store data, configuration circuit 13 to store configuration information, and control circuit 12 to control the operation of configuration circuit 13. Memory 10 may be part of a larger memory system that may include other types of memory (not shown).

[0016] Memory 10 can be coupled to CPU 19 via a memory bus 18. In one embodiment, bus 18 can include multiple data lines DATA-xx, multiple address lines ADDR-yy, chip enable line CE#, write enable line WE#, cold reset line COLD RESET#, and warm reset line WARM RESET#. COLD RESET# can be activated when the system is powered up, while WARM RESET# can be activated when the system is restarted but is already powered up. The cold and warm reset functions can also be activated under other circumstances, as is known to those of skill in the art.

[0017] DATA-xx can be comprised of multiple bi-directional data lines to carry data that is being read from memory array 11 and data that is being written into memory array 11. The DATA-xx lines can also be used to write/read configuration information to/from configuration circuit 13. Address lines ADDR-yy can be used to specify the address in memory array 11 at which the data on lines DATA-xx is being written to or read from. One or more addresses may be reserved to specify configuration circuit 13 so that data can be communicated to/from configuration circuit 13 over bus 18 much as it would to/from a location in memory array 11. Chip enable line CE# can carry a signal that selects memory 10 for read or write operations. In one embodiment, asserting the chip enable signal causes a power-up of memory 10, which otherwise remains in a low-power state. Asserting a signal on write enable line WE# can indicate that a write operation is taking place. In one embodiment, the data on data lines DATA-xx can be latched into memory 10 on the low-to-high transition of WE#.

[0018] Signals on the lines COLD RESET# and WARM RESET# can be asserted to indicate a cold reset and warm reset condition, respectively. In one embodiment, a cold reset indicates the system is to restart from a powered-off state, while a warm reset indicates the system is being restarted from a powered-on state. A warm reset typically causes a warm boot operation, in which some of the configuration or state data in CPU 19 is assumed to be correct and is not reloaded. A cold reset typically causes a cold boot operation, in which all volatile configuration or state data is reloaded into CPU 19 from scratch. A cold boot typically occurs upon power-up of the system. In some embodiments, there are more than two restart conditions. Each of these can be associated with one of the two reset signals of Fig. 1. Alternately, more than two reset signals (not shown) can be sent to CPU 19 and/or memory 10 to represent the various restart conditions.

[0019] Fig. 2 shows a more detailed view of one embodiment of circuit 13 for receiving, storing, and providing configuration data. Latches 21-0 through 21-m can collectively form a non-volatile register to store default configuration data, with each latch storing one bit of the default configuration data. The number of latches may

5 depend on the amount of configuration data needed. This is shown by designating the last configuration bit as “m”. These latches can be referred to generically as 21-x, with the “x” representing any or all of the bit positions 0 through m. Because latches 21-x are non-volatile, they can hold their data even when power is removed from circuit 13. In one embodiment, latches 21-x can be hardwired into circuit 13 when circuit 13 is

10 manufactured. In another embodiment, latches 21-x can be comprised of one-time programmable read-only memory, which can be programmed with default configuration data at a suitable point in the manufacturing/ assembly/ distribution process. In another embodiment, latches 21-x can be comprised of reprogrammable non-volatile memory, such as flash memory. These different types of non-volatile

15 storage can also be combined in register 21 by using different types in different latches.

[0020] Default configuration data can be the configuration data that is predicted to be the most likely needed set of configuration data for the intended application(s) of the associated memory 10. This most-likely-needed designation might be based on a number of things, including but not limited to:

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- 1) the intended product(s) in which memory 10 is to be used,
 - 2) the particular version of those product(s),
 - 3) the application software to be used in the product in which memory 10 is to be used,
 - 4) the particular version of that software, or
 - 5) anticipated needs of the end user.

[0021] Latches 22-0 through 22-n can collectively form a volatile register that can store active configuration data. Active configuration data can be the configuration data that is being used in memory 10, or that is to be used shortly. The number of latches in the volatile register may depend on the amount of configuration data needed.

5 This is shown by designating the last configuration bit as “n”. The latches of this volatile register can be referred to generically as latches 22-x, where x can be any of the bit positions 0 through n. Latches 22-x can be programmed by loading data into them from other sources such as non-volatile latches 21-x or from an alternate source.

[0022] In Fig. 2, the alternate source is indicated by input logic 28 that includes

10 individual input bits 28-0 through 28-p, where p is the number of bit positions represented. These can be referred to generically as input bits 28-x. In one embodiment, input bits 28-x can convey programmable configuration data provided over bus 18 by processor 19 when it dynamically loads volatile latches 22-x. This can permit the processor to determine which configuration data is to be used, and
15 dynamically place it into volatile latches 22-x where it can be used to define the configuration of memory 10. In another embodiment, the programmable input data of input logic 28-x can be provided from data stored in other registers or memory locations (not shown). In this manner, one or more alternate configurations can be pre-determined and placed into storage for immediate use by circuit 13 without requiring
20 the software of CPU 19 to determine exactly what the alternate configuration should be.

[0023] In one embodiment, non-volatile register 21, volatile register 22, and input logic 28 can each have the same number of bits, as is implied by the circuit of Fig. 2. In other embodiments, they may have a different number of bits, as is implied by the use of different designators “m”, “n”, and “p”. There can be several reasons for
25 this, which include but are not limited to:

1) The default configuration may be more (or less) limited than the programmable configuration in the scope of the configuration it defines, thereby requiring fewer (or more) bits.

2) It may be desirable to keep some configuration bits the same for both the default and the programmable configurations, thus requiring fewer input bits 28-x.

[0024] The programmable configuration data from input logic 28 can be written into latches 22-x with signal WE#, or the equivalent of this signal. In the illustrated embodiment, WE# can be the buffered write enable from bus 18, with the low-to-high transition of WE# causing each latch 22-x to clock in the data appearing at the data input of the latch, which can be the data appearing on data lines DATA-xx of Fig. 1. In this manner, the data from input logic 28 can replace whatever configuration data had previously been placed in register 22.

[0025] When the system experiences a cold reset condition, signal COLD RESET# can be asserted. In one embodiment, the cold reset condition can be a power-up condition, and the COLD RESET# signal can be a power-up reset signal. The affect of this on circuit 13 can be illustrated by describing its affect on latch 22-0. By common convention, the '#' in the signal name COLD RESET# indicates that it is asserted by bringing its signal voltage low. This will cause the output of AND gate 25, and therefore the connected inputs of OR gates 23-0 through 23n (23-x) and 24-0 through 24-n (24-x), to become low. This in turn permits the output of non-volatile latches 21-0 through 21-m (21-x) to control the Set and Reset inputs of corresponding volatile latches 22-x. A logic '1' in any latch 21-x will cause corresponding latch 22-x to be set, making its output a logic 1. A logic '0' in any latch 21-x will cause corresponding latch 22-x to be reset, making its output a logic 0. A COLD RESET#

signal can therefore load the contents of non-volatile register 21 into volatile register 22, making the default configuration the active, or operational, configuration.

[0026] When the system is restarted from a previously powered-up state, or

otherwise experiences a warm reset, additional logic can be employed. If a WARM

5 RESET# signal is asserted by bringing the signal low, that permits the state of Reset Config Bit 27 to control whether the warm reset signal is propagated to the other input of AND gate 25. If the output of Reset Config Bit is high when WARM RESET# is low, the output of OR gate 26 and the connected inputs of AND gate 25 will be low.

This makes the output of AND gate 25 low, and forces the contents of non-volatile

10 register 21 to be loaded into volatile register 22 in a similar manner to that described in the previous paragraph. If the output of Reset Config Bit is low, the output of OR gate 26 and the connected input of AND gate 25 will both be high. Except for a cold reset, this condition makes the outputs of AND gate 25, OR gates 23-0 through 23-n (23-x), and OR gate 24-0 through 24-n (24-x) all high, effectively disabling the Set and Reset
15 inputs of latches 22-0 through 22-n (22-x). In this condition, the contents of latches 22-x remain unchanged even though a warm reset is being performed on the system. This effectively permits the system to be rebooted with the same memory configuration that it had before the warm reset was initiated.

[0027] Thus, the state of the Reset Config Bit 27 can determine whether a warm

20 reset will reload the active configuration register 22 with the default configuration data, or leave the previous configuration data in register 22 unchanged. In one embodiment, reset configuration bit 27 can be programmed by CPU 19 in any manner known to those of skill in the art.

[0028] Fig. 3 shows a flow chart 30 of a method embodiment. Block 31

25 provides default configuration data in a non-volatile register, i.e., a register that does

not lose its contents when electrical power is removed from the register. In various embodiments, the non-volatile register can be formed of permanent latches, one-time programmable latches, or reprogrammable latches such as flash memory. Block 32 provides programmable configuration data from an input logic circuit. In one

5 embodiment, the input logic circuit can provide data obtained from the data lines of a memory bus. At block 33, active configuration data is selected from either the default configuration data in the non-volatile register or the programmable configuration data provided by the input logic circuit. At block 34, the selected active configuration data is loaded into an active configuration register, which can be a volatile register. At

10 block 35, the active configuration data in the active configuration register is used to specify an operational memory configuration. In one embodiment, this active configuration may be implemented immediately to configure the associated memory. In another embodiment, this active configuration may be implemented upon the occurrence of a pre-determined event, such as the initiation of a memory

15 reconfiguration request by the software.

[0029] Fig. 4 shows a flow chart 40 of a method embodiment involving a reset operation. At block 41, a reset operation is initiated in the system. At block 42, it is determined whether or not this is a power-up reset. If it is, at block 43 the active configuration register is loaded with default configuration data from the default

20 configuration register. If it is not, a reset configuration bit is examined at block 44. In one embodiment, this reset configuration bit can be previously programmed to the desired state. To avoid obscuring the invention, the process for programming a configuration bit is not described, but can be implemented in various known ways by a person of ordinary skill in the art. If the reset configuration bit is in a first state (for

25 example, a logic '1'), the active configuration register can be loaded with default

configuration data from a default configuration register at block 43. If the reset configuration bit is not in the first state (for example, it is a logic '0'), the contents of the active configuration register can be left intact at block 45, i.e., the register's contents can remain equal to its previous contents.

- 5 **[0030]** The foregoing description is intended to be illustrative and not limiting. Variations will occur to those of skill in the art. Those variations are intended to be included in the invention, which is limited only by the spirit and scope of the appended claims.